

PRODUCT / PROCESS CHANGE NOTIFICATION

PCN-000295 - Minor

Date: 03/18/2015 P1/1

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Semtech Irvine, 5141 California Ave., Suite 100, Irvine CA 92617 Semtech Neuchatel Sarl, Route des Gouttes d'Or 40, CH-2000 Neuchatel Switzerland									
Nanotech Semiconductor, Semtech Corporation, 2 West Point Court, Bristol, United Kingdom, BS32 4PY									
·	Semtech Corpus Christi SA de CV, Carretera Matamorros Edificio 7, Reynosa, Tamaulipas, Mexico 88780								
	Chan	ge Details							
Part Number(s) Affected:									
Description, Purpose and Effect of Change: Lead Frame (222000625) will not be available for the assembly SBMA2F. No supplier will be able to produce or get this specific part number (Lead frame). As an alternative for this part there is a Tin lead bus bar AWG 20 (215012503), which is a standard replacement being used in a similar assemblies (like SBR2F). This 215012503 can be used instead.									
Change Classification	☐ Major ⊠ Minor	☐ Major ☑ Minor Impact to Form, Fit, ☐ Yes ☑ No							
Impact to Data Sheet	☐ Yes ⊠ No	New Revision or Date	⊠ N/A						
Impact to Performance NO IMPACT TO THE PERFO		Reliability: AND OTHER CHARACTERISTI	CS.						
Implementation Date	6/18/2015	Work Week	1525						
Last Time Ship (LTS) Of unchanged product	6/18/2015	Affecting Lot No. / Serial No. (SN)	M067570						
Sample Availability	3/10/2015	Qualification Report Availability	3/10/2015						
 Supporting Document Qualification Report Semtech Catalog Da 									
	Issuing	g Authority							
Semtech Business Unit:	PHR-Legacy	•							
Semtech Business Unit: PHR-Legacy Pat Sanchez Semtech Corporation Sr. Manager, Corporate Quality 200 Flynn Road Camarillo, CA 93012 Psanchez@semtech.com Office: (805) 480-2074 Fax: (805) 498-3804									
FOR FURTHER INFORMATION & WORLDWIDE SALES COVERAGE: http://www.semtech.com/contact/index.html#support									



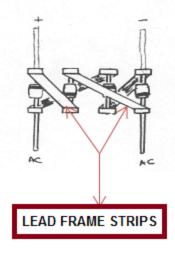


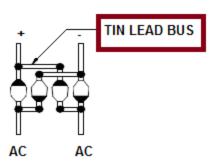
SBMA2F:CHANGE FROM LEAD FRAME(222000625) TO TIN LEAD BUS BAR (215012503)

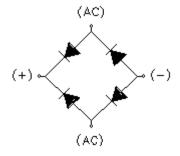
Reason For Change:



Lead Frame(222000625) is not available for Assy SBMA2F. As an alternative for this part there is a Tin lead bus bar AWG 20 (215012503) that is a standard replacement being used in a similar Assy SBMA2F (SBR2F) can be used instead

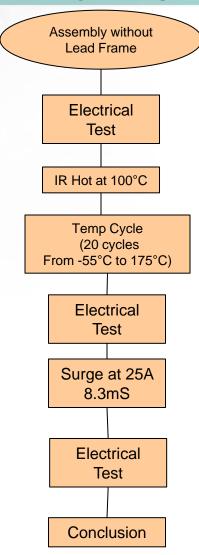








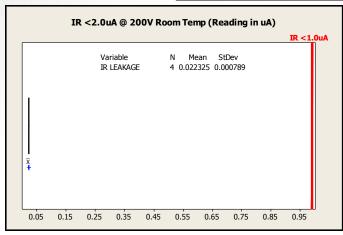
PLAN TO VALIDATE THE CHANGE

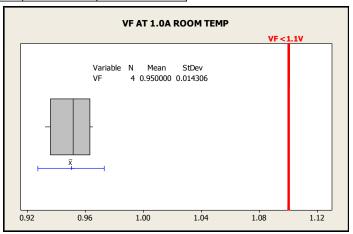


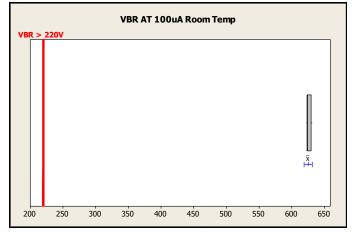


Electrical Data at Room Temp

Test	2		3	4	5	
Item		POLA	IR LEAKAGE	VF	VBR	
Limit		2.000 V	< 1.000uA	<1.100 V	>220.0 V	
Bias 1			AT 200 V	AT 1.00 A	AT 100 uA	
Time	BIN GOOD	5.000ms	20.00ms	8.300ms	20.00ms	
1	5	9.999	0.0214uA	0.932mV	623.1V	
2	5	9.999	0.0227uA	0.965mV	622.2V	
3	5	9.999	0.0232uA	0.957mV	630.7V	
4	5	9.999	0.022uA	0.946mV	623.9V	



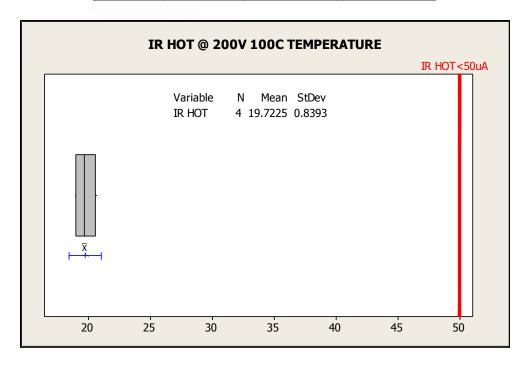






IR HOT at 100°C

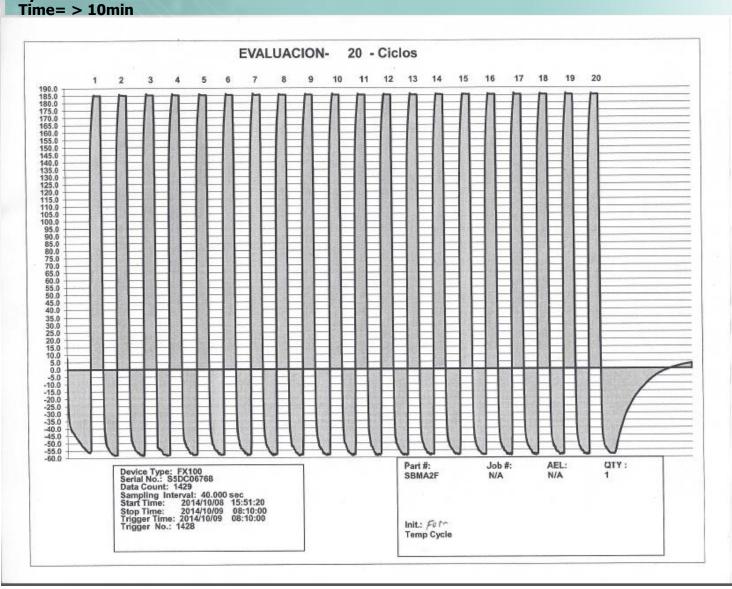
Test		2	3
Item		POLA	IR LEAKAGE
Limit		2.000 V	50.00uA
Bias 1		IAK 50.0uA	AT 200 V
Bias 2			
Time	BIN GOOD	5.000ms	20.00ms
1	4	9.999	20.21uA
2	4	9.999	19.1uA
	4	9.999	20.65uA
4	4	9.999	18.93uA



TEMP CYCLE:

Low Temp= -55° C High Temp= 175°C Cycles = 20

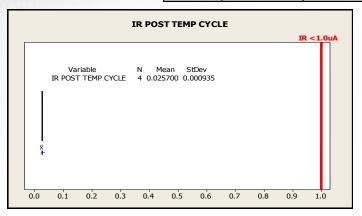


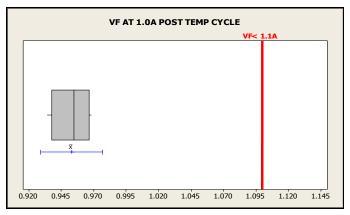


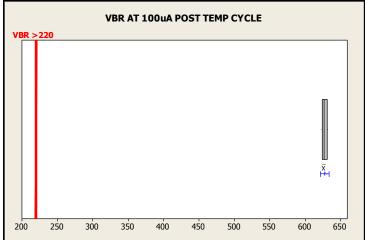


Electrical Test Post Temp Cycle

Test		2	3	4	5
Item		POLA	IR	VF	VBR
Limit		2.000 V	< 1.000uA	<1.100 V	>220.0 V
Bias 1			AT 200 V	1.00 A	AT 100 uA
Time	BIN GOOD	5.000ms	20.00ms	8.300ms	20.00ms
1	5	9.999	0.0246uA	0.934mV	623.5V
2	5	9.999	0.0253uA	0.968mV	624.9V
3	5	9.999	0.0267uA	0.961mV	629.4V
4	5	9.999	0.0262uA	0.948mV	631.8V



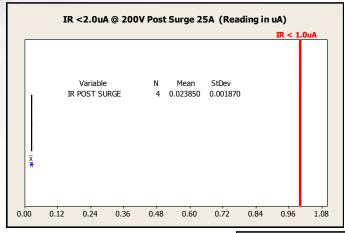


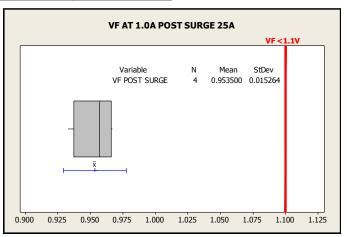


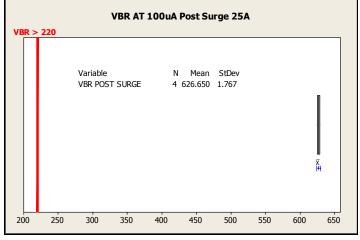


Electrical Test Post Surge at 25A

Test		2 3 4		4	5
Item		POLA	IR	VF	VZ
Limit		2.000 V	< 1.000uA	<1.100 V	>220.0 V
Bias 1			AT 200 V	1.00 A	AT 100 uA
Time	BIN GOOD	5.000ms	20.00ms	8.300ms	20.00ms
1	5	9.999	0.0229uA	0.933mV	624.5V
2	5	9.999	0.0234uA	0.967mV	626.9V
3	5	9.999	0.0225uA	0.963mV	626.4V
4	5	9.999	0.0266uA	0.951mV	628.8V

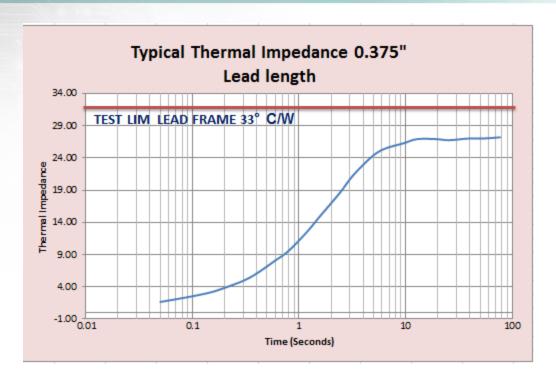








Thermal Resistance





Conclusion

SUMMARY										
				Repetitive						
		Working	1 Cycle Surge	Surge			Forward			
	Reverse		Current	Current	Reverse	Leakage	Voltage			
		Voltage	IFSM Tp=8.3mS	IFSM	Current IR	@ VRWM	VF @ 1A/Leg			
		VRWM	AT 25° C	AT 25° C	AT 25° C	AT 100° C	AT 25° C			
Lead Type	Device Type	Volts	Amps	Amps	μΑ	μΑ	Volts			
Lead Frame	SBMA2F	200	25A	10	1.0uA	50uA	1.1			
Tin Lead Bus	SBMA2F	200	25A	10	~ 27nA	~ 19.7uA	~ 0.953V			

Base on the executed tests for the change validation from the lead frame to Tin Lead; it was determinate that the implementation of this change of lead has no impact in the electrical performance of the product SBMA2F

FAST RECOVERY 1 PHASE SILICON BRIDGE RECTIFIERS

3SBM*05F thru 3SBM*4F

January 16, 1998

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FAST RECOVERY, PCB MOUNTING, 1-PHASE FULL WAVE BRIDGE RECTIFIER ASSEMBLIES

- Low forward voltage drop
- Low reverse leakage current
- Subminiature design
- Three lead configurations
- Fast reverse recovery time

QUICK REFERENCE DATA

• $V_R = 50V - 400V$

• $I_F = 3.0A$

• $I_R = 2.0 \, \mu A$

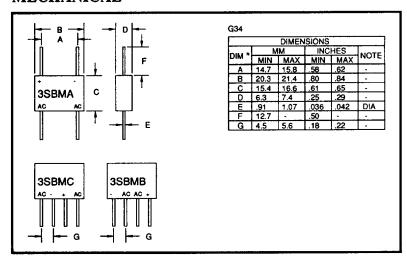
• $t_{rr} = 150 nS$

ABSOLUTE MAXIMUM RATINGS & CHARACTERISTICS

Device Type	Working Reverse Voltage	Rectified	ıαgc	1 Cycle Surge Current I _{FSM} t _p = 8.3mS	Repetitive Surge Current I _{FRM}	Reverse Leakage Current I _R @ V _{RWM}		Forward Voltage drop V _F @ 3A/leg @ 25°C	Reverse Recovery Time t _{rr}
,	V _{RWM}	@ 55°C	@ 100°C	@ 25°C	@ 25°C	@ 25°C	@ 100°C		@ 25°C
	Volts	Amps	Amps	Amps	Amps	μΑ	μΑ	Volts	nS
3SBM*05F	50	3.0	1.5	150	25	2.0	40	1.1	150
3SBM*1F	100	3.0	1.5	150	25	2.0	40	1.1	150
3SBM*2F	200	3.0	1.5	150	25	2.0	40	1.1	150
3SBM*4F	400	3.0	1.5	150	25	2.0	40	1.1	150

^{*} Add A, B, C for desired circuit configuration (see Mechanical outline)

MECHANICAL



¹ Measured on discrete devices prior to assembly

January 16, 1998

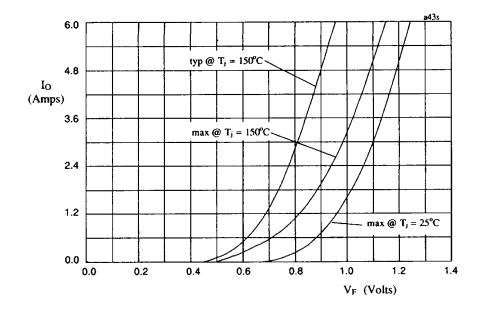


Fig 1. Forward voltage drop against output current per leg

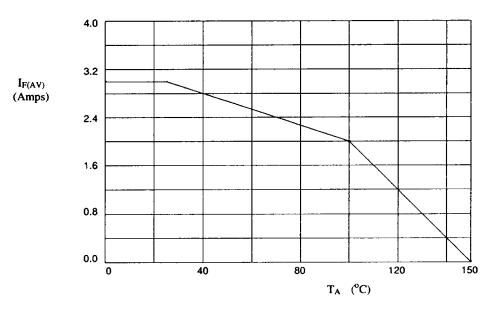


Fig 2. Maximum average forward current against ambient temperature.